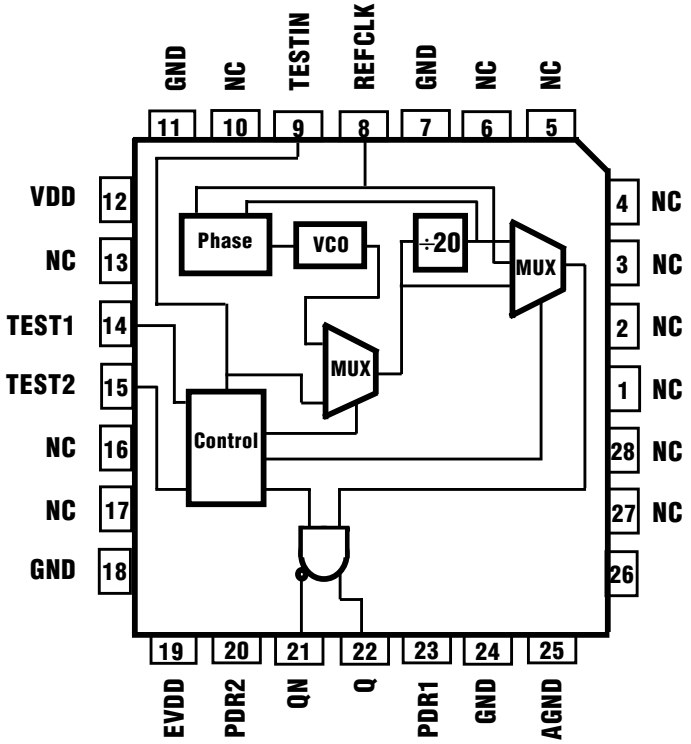
TQ2061

High-Frequency Clock Generator

Figure 1. Pinout Diagram



TriQuint's TQ2061 is a high-frequency clock generator. It utilizes a 25 MHz to 35 MHz TTL input to generate a 500 MHz to 700 MHz PECL output. The TQ2061 has a completely self-contained Phase-Locked Loop (PLL) running at 500 MHz to 700 MHz. This stable PLL allows for a low period-to-period output jitter of 70 ps (max), and enables tight duty cycle control of 55% to 45% (worst case).

The TQ2061 provides optional 200-ohm on-chip pull-down resistors which are useful if the output is AC-coupled to the device being driven. In order to use these resistors, pin 20 (PDR2) should be connected to pin 21 (QN), and pin 23 (PDR1) should be connected to pin 22 (Q).

Various test modes on the chip simplify debug and testing of systems by slowing the clock output or by bypassing the PLL.

Features

- *Output frequency range: 500 MHz to 700 MHz*
- *One differential PECL output: 600 mV (min) swing*
- *Common-mode voltage: V_{DD} –1.2 V (max), V_{DD} –1.6 V (min)*
- *Period-to-period output jitter: 25 ps peak-to-peak (typ) 70 ps peak-to-peak (max)*
- *Reference clock input: 25 MHz to 35 MHz TTL-level crystal oscillator*
- *Self-contained loop filter*
- *Optional 200 Ω pull-down resistors for AC-coupled outputs*
- *+5 V power supply*
- *28-pin J-lead surface-mount package*
- *Ideal for designs based on DEC Alpha AXP™ processors*

SYSTEM TIMING PRODUCTS

Figure 2. Simplified Block Diagram

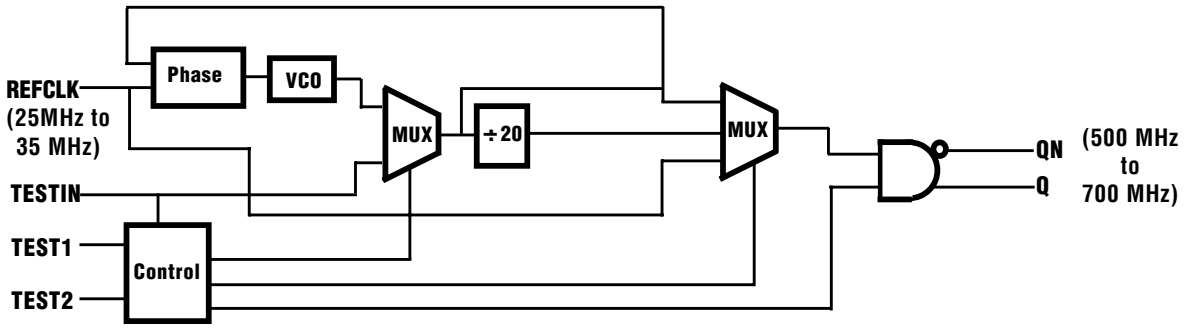


Table 1. Mode Selection

Mode	*TEST1*	*TEST2*	*TESTIN* [1]	*REFCLK*	*Q, QN*
1 (Test)	0	0	"don't care"	f_{REFCLK}	f_{REFCLK}[2]
2 (Test)	0	1	"don't care"	"don't care"	0, 1
3 (Test)	1	0	$f_{TESTCLK}$	"don't care"	$f_{TESTCLK}$
4 (Bypass)	1	1	0	f_{REFCLK}	f_{REFCLK}
5 (Normal)	1	1	1	f_{REFCLK}	20 x f_{REFCLK}[3]

Notes: 1. In mode 3, TESTIN may be used to bypass the PLL.
2. REFCLK = 25 MHz to 35 MHz.
3. Q, QN = 500 MHz to 700 MHz.

Figure 3. Recommended Layout
(Not to scale)

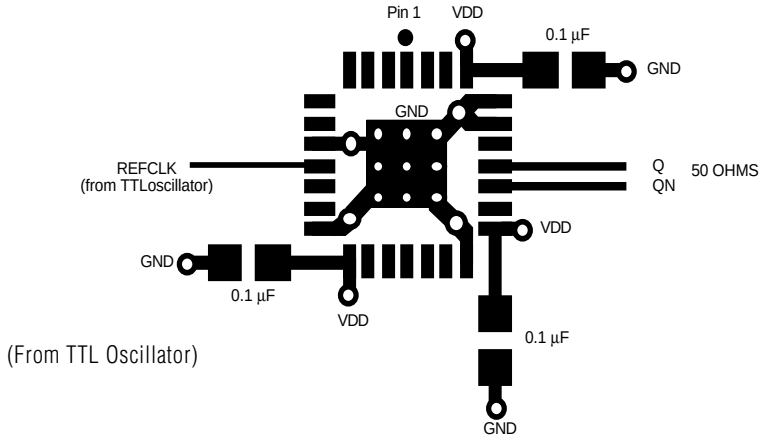


Table 2. Absolute Maximum Ratings

Storage Temperature	–65°C to +150°C
Ambient temperature with power applied	–55°C to +110°C
Supply voltage to ground potential	–0.5 V to +7.0 V
DC input voltage	–0.5 V to (V_{DD} + 0.5) V
DC input current	–30 mA to +5 mA
Package thermal resistance (MQuad)	θ_{JA} = 45°C/W
Die junction temperature	T_J = 150°C

Note: Stresses above those listed in Absolute Maximum Ratings may cause permanent damage to the device. The device should be operated only under the DC and AC conditions shown below.

Table 3. DC Characteristics (V_{DD} = +5 V ± 5%, T_A = 0 °C to +70 °C) [1]

Symbol	*Description*	*Test Conditions*	*Min*	*Typ*	*Max*	*Unit*
V_{OH}	Output HIGH voltage	V_{CC} = Min PECL load	V_{CC} – 1.20		V_{CC} – 0.50	V
V_{OL}	Output LOW voltage	V_{CC} = Min PECL load	V_{CC} – 2.00		V_{CC} – 1.60	V
V_{CMO}	Output common mode voltage	PECL	V_{CC} – 1.60		V_{CC} – 1.20	V
Δ V_{OUT}	Output differential voltage	PECL	0.6		1.2	V
V_{IH} [2]	Input HIGH level	Guaranteed input logical HIGH Voltage for all inputs	2.0			V
V_{IL} [2]	Input LOW level	Guaranteed input logical LOW Voltage for all inputs			0.8	V
I_{IL}	Input LOW current	V_{DD} = Max V_{IN} = 0.40 V		–150	–400	µA
I_{IH}	Input HIGH current	V_{DD} = Max V_{IN} = 2.7 V		0	25	µA
I_I	Input HIGH current	V_{DD} = Max V_{IN} = 5.3 V		2	1000	µA
I_{DDS} [3]	Power supply current	V_{DD} = Max		85	120	mA
V_I	Input clamp voltage	V_{DD} = Min I_{IN} = –18 mA		–0.70	–1.2	V

Table 4. Capacitance

Symbol	*Description*	*Test Conditions*	*Min*	*Typ*	*Max*	*Unit*
C_{IN}	Input Capacitance	V_{IN} = 2.0 V at f = 1 MHz		6		pF
C_{OUT}	Output Capacitance	V_{OUT} = 2.0 V at f = 1 MHz		9		pF

Notes: 1. Typical limits are at V_{DD} = 5.0 V and T_A = 25°C.
2. These are absolute values with respect to device ground and include all overshoots due to system or tester noise.
3. This parameter is measured with device not switching and unloaded.

Table 5. AC Characteristics (V_{DD} = +5 V ± 5%, T_A = 0 °C to +70 °C)

Symbol	Input Clock (REFCLK)	Test Conditions (Figure 5)	Min	Typ	Max	Unit
t_{CPWH}	CLK pulse width HIGH	Figure 5	4	—	—	ns
t_{CPWL}	CLK pulse width LOW	Figure 5	4	—	—	ns
t_{IR}	Input rise time (0.8 V – 2.0 V)		—	—	2.0	ns

Symbol	Output Clock (Q, QN)	Test Conditions (Figures 4 & 5)[1]	Min	Typ	Max	Unit
t_{OR}, t_{OF}	Rise/fall time (20% – 80%)	Figure 5	100	220	350	ps
t_{CYC}	Duty-cycle	Figure 5	45	50	55	%
t_{JP}[2]	Period-to-Period Jitter		—	25	70	ps
t_{SYNC}[3]	Synchronization Time		—	10	500	µs

Notes: 1. All measurements are tested with a REFCLK having a rise time of 0.5 ns (0.8 V to 2.0 V).
2. Jitter specification is peak to peak. Period-to-Period jitter is the jitter on the output with respect to the output's previous crossing.
3. t_{SYNC} is the time required for the PLL to synchronize and assumes the presence of a CLK signal.

Figure 4. PECL Test Load

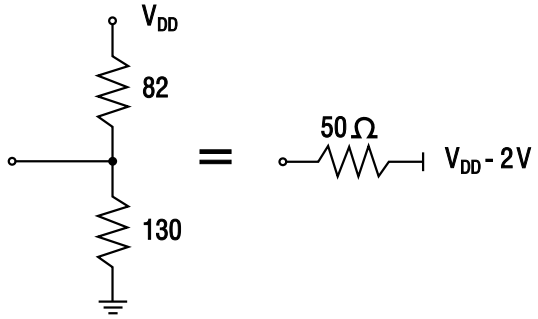


Figure 5. REFCLK and Q–QN Timing

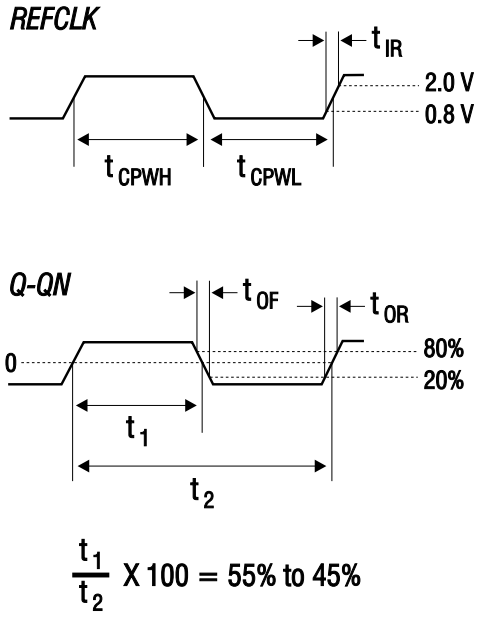
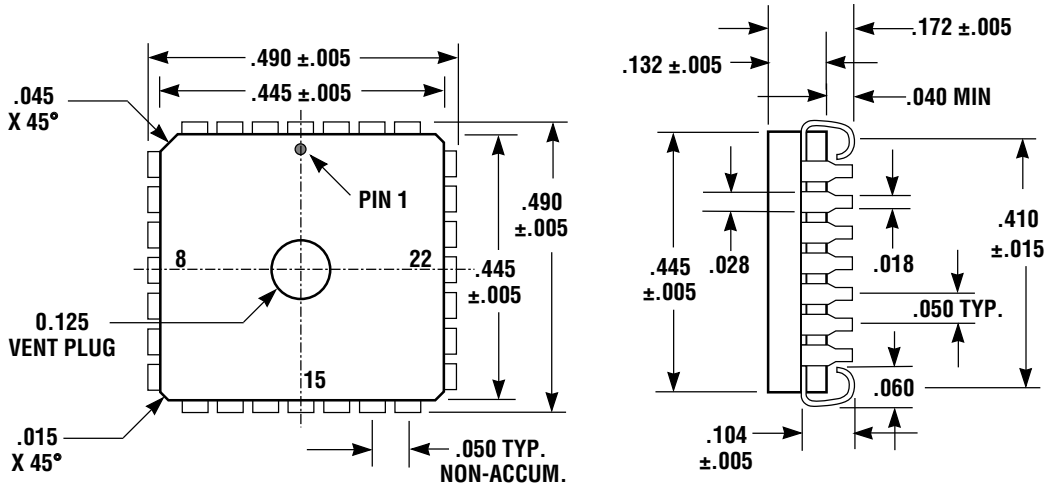


Figure 6. 28-Pin MQuad J-Leaded Package Mechanical Specification



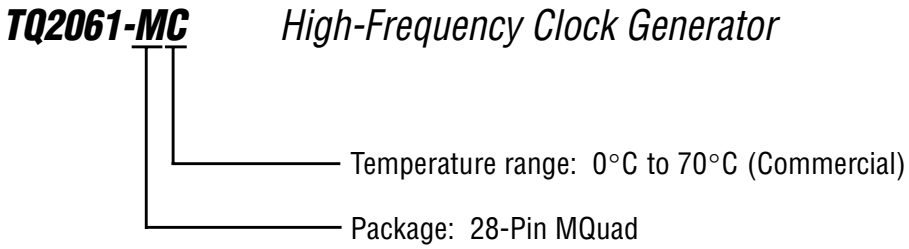
(All dimensions in inches)

Table 6. 28-Pin MQuad Pin Description

Pin #	*Pin Name*	*Description*	*I/O*
1	NC	No Connect	—
2	NC	No Connect	—
3	NC	No Connect	—
4	NC	No Connect	—
5	NC	No Connect	—
6	NC	No Connect	—
7	GND	Ground	—
8	REFCLK	Reference Clock	I
9	TESTIN	Test Input	I
10	NC	No Connect	—
11	GND	Logic Ground	—
12	VDD	Logic VDD (+5 V)	—
13	NC	No Connect	—
14	TEST1	Test Control 1	I
15	TEST2	Test Control 2	I
16	NC	No Connect	—
17	NC	No Connect	O
18	GND	Ground	—
19	EVDD	VDD for ECL Output (+5 V)	—
20	PDR2	Pull-down Resistor 2 (200 Ω)	I
21	QN	Differential PECL Output (–)	O
22	Q	Differential PECL Output (+)	O
23	PDR1	Pull-down Resistor 1 (200 Ω)	I
24	GND	Ground	—
25	AGND	Analog Ground	—
26	AVDD	Analog VDD (+5 V)	—
27	NC	No Connect	—

Ordering Information

To order, please specify as shown below:



Additional Information

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Email: sales@tqs.com **Fax: (503) 615-8900**

For technical questions and additional information on specific applications:

Email: applications@tqs.com

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